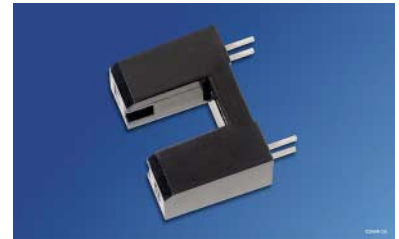


Gabellichtschranke
Slotted Interrupter
Lead (Pb) Free Product - RoHS Compliant
SFH 9315



Wesentliche Merkmale

- Kompaktes Gehäuse
- GaAs-IR-Sendediode (950 nm)
- Si-Fototransistor mit Tageslichtsperrfilter

Anwendungen

- Geschwindigkeitsüberwachung
- Motorsteuerung
- Überwachung des Papiervorschubs in Druckern, Kopier- und Faxgeräten
- Speicherlaufwerke
- Steuerung des Druckkopfes in Druckern
- Münzdetektion
- Optoelektronische Schalter

Features

- Compact type
- GaAs infrared emitter (950 nm)
- Silicon phototransistor detector with daylight-cutoff filter

Applications

- Speed control
- Motor control
- Monitoring of paper feed in printers, copiers, facsimiles
- Disk drives
- Control of print head in printers
- Coin detection
- Optoelectronic switches

Type Type	Bestellnummer Ordering Code	$I_{CE\ min.}$ [mA] ($I_F = 20\ mA$; $V_{CE} = 5\ V$)
SFH 9315	Q65110A1216	0.7

Grenzwerte $T_A = 25\text{ °C}$ **Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Sender (GaAs-Diode) Emitter (GaAs Diode)			
Sperrspannung Reverse voltage	V_R	5	V
Durchlaßstrom Forward current	$I_{F(DC)}$	40	mA
Verlustleistung Power dissipation	P_{tot}	65	mW
Wärmewiderstand Thermal resistance	R_{thJA}	280	K/W

Empfänger (Si-Fototransistor)**Detector (Silicon Phototransistor)**

Kollektor-Emitter-Spannung Collector-emitter voltage	V_{CE}	15	V
Kollektor-Emitter-Spannung, ($t \leq 2$ min) Collector-emitter voltage, ($t \leq 2$ min)	V_{CE}	30	
Emitter-Kollektor-Spannung Emitter-collector voltage	V_{EC}	7	
Kollektorstrom Collector current	I_C	15	mA
Verlustleistung Total power dissipation	P_{tot}	65	mW
Wärmewiderstand Thermal resistance	R_{thJA}	280	K/W

Gabellichtschranke**Slotted Interrupter**

Lagertemperatur Storage temperature range	T_{stg}	- 40 ... + 85	°C
Betriebstemperatur Operating temperature range	T_{op}	- 40 ... + 85	
Elektrostatische Entladung Electrostatic discharge	ESD	2	kV

Kennwerte $T_A = 25\text{ °C}$ **Characteristics**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Sender (GaAs-Diode)			
Emitter (GaAs Diode)			
Wellenlänge der Strahlung Wavelength of peak emission	λ_{peak}	950	nm
Durchlaßspannung Forward voltage $I_F = 20\text{ mA}, t_p = 20\text{ ms}$	V_F	1.2 (≤ 1.4)	V
Sperrstrom Reverse current $V_R = 5\text{ V}$	I_R	0.01 (≤ 1)	μA
Kapazität Capacitance $V_R = 0\text{ V}, f = 1\text{ MHz}$	C_0	16	pF

Empfänger (Si-Fototransistor)**Detector (Silicon Phototransistor)**

Wellenlänge der max. Fotoempfindlichkeit Wavelength of max. sensitivity	$\lambda_{S\text{ max}}$	920	nm
Spectr. Bereich der Fotoempfindlichkeit Spectral range of sensitivity $S = 10\%$ of S_{max}	λ	840 ... 1080	nm
Kapazität Capacitance $V_{CE} = 0\text{ V}, f = 1\text{ MHz}, E = 0$	C_{CE}	4.5	pF
Dunkelstrom Dark current $V_{CE} = 20\text{ V}$	I_{CEO}	2 (≤ 50)	nA

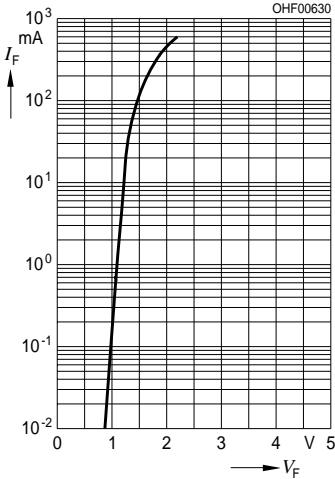
Kennwerte $T_A = 25\text{ °C}$
 Characteristics (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
--------------------------	------------------	---------------	-----------------

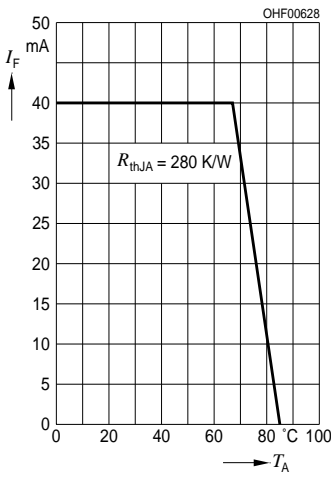
Gabellichtschranke
Slotted interrupter

Kollektor-Emitterstrom Collector-emitter current $I_F = 20\text{ mA}; V_{CE} = 5\text{ V}$	$I_{CE\text{ min.}}$	0.7	mA
Kollektor-Emitter-Sättigungsspannung Collector-emitter-saturation voltage $I_F = 20\text{ mA}; I_C = 0.2\text{ mA}$	$V_{CE\text{ sat}}$	≤ 0.4	V
Anstiegs- und Abfallzeit Rise and fall time $V_{CC} = 5\text{ V}, I_C = 1\text{ mA}, R_L = 1\text{ k}\Omega$	t_r t_f	13 17	μs μs

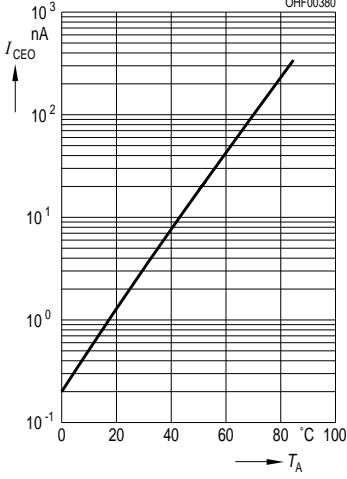
Forward Current $I_F = f(V_F)$
Single pulse, $t_p = 20 \mu s$



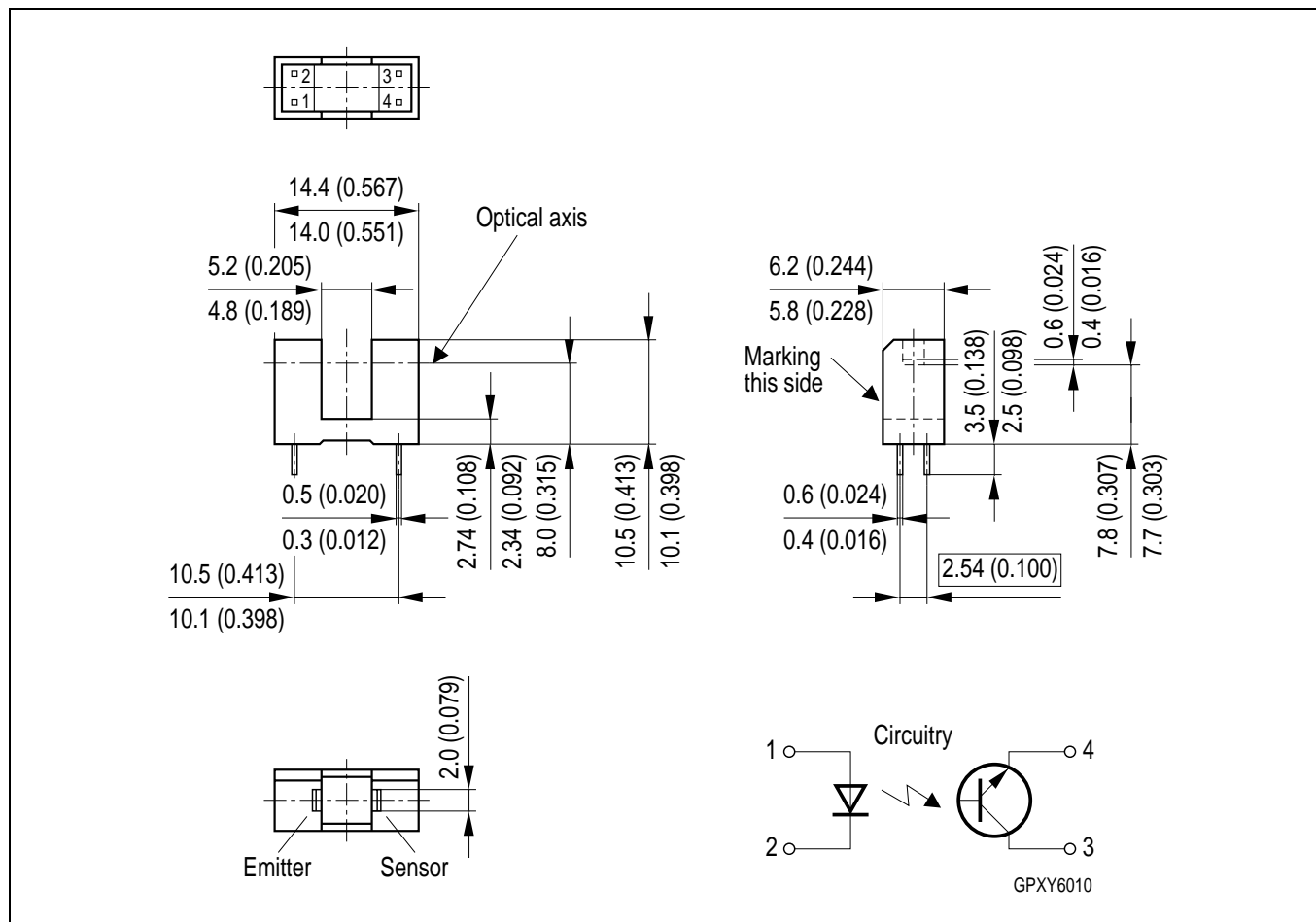
Max. Permissible Forward Current $I_F = f(T_A)$



Dark Current $I_{CEO} = f(T_A)$
 $V_{CE} = 20 \text{ V}, E = 0$



Maßzeichnung
Package Outlines



Maße in mm (inch) / Dimensions in mm (inch).

Löthinweise Soldering Conditions

Bauform Type	Tauch-, Schwalllötung Dip, Wave Soldering		Reflowlötung Reflow Soldering		Kolbenlötung Iron Soldering (Iron temp.)
	Peak Temp. (solderbath)	Max. Time in Peak Zone	Peak Temp. (package temp.)	Max. Time in Peak Zone	
SFH 9315	260 °C	10 s	n. a.	–	300 °C < 5 s

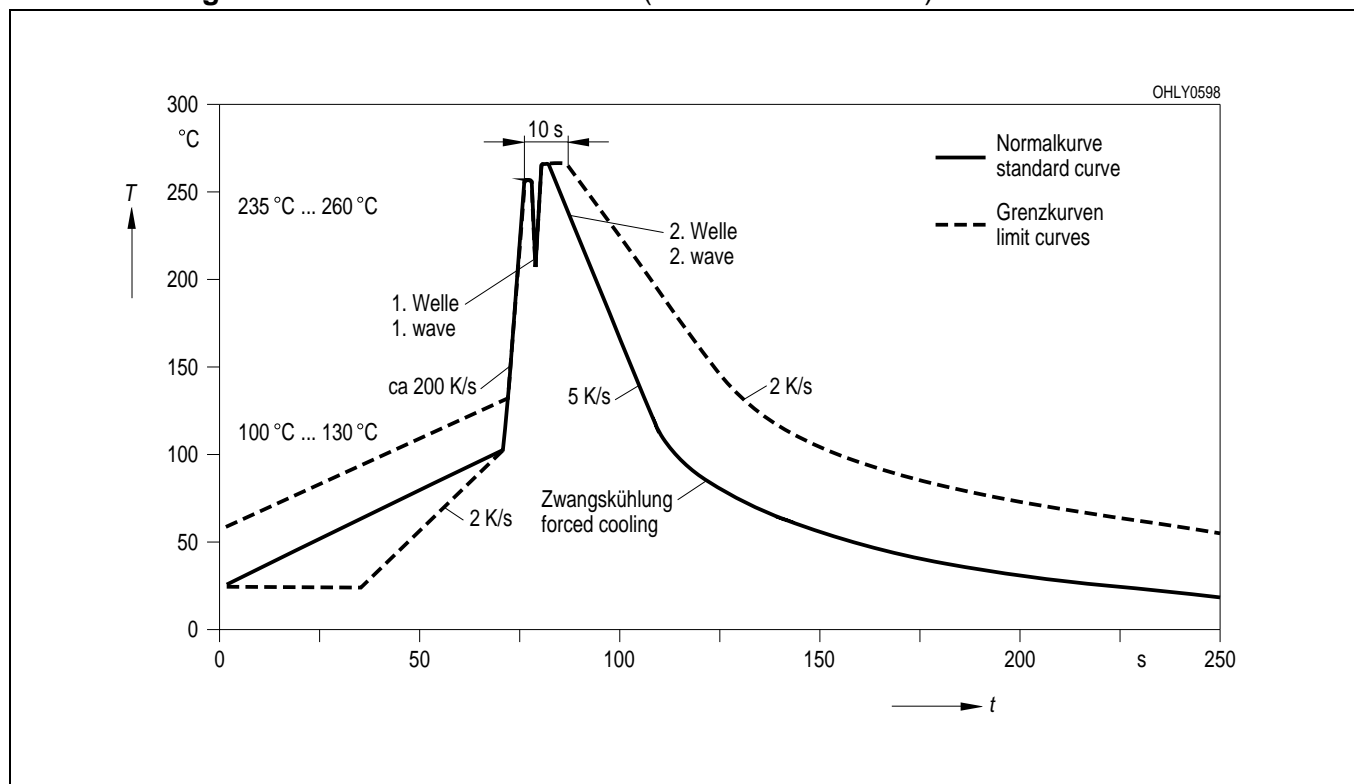
Lötbedingungen Soldering Conditions

Wellenlötten (TTW)

(nach CECC 00802)

TTW Soldering

(acc. to CECC 00802)



Published by OSRAM Opto Semiconductors GmbH
Wernerwerkstrasse 2, D-93049 Regensburg

www.osram-os.com

© All Rights Reserved.

Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances. For information on the types in question please contact our Sales Organization.

Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

Components used in life-support devices or systems must be expressly authorized for such purpose! Critical components ¹, may only be used in life-support devices or systems ² with the express written approval of OSRAM OS.

¹ A critical component is a component used in a life-support device or system whose failure can reasonably be expected to cause the failure of that life-support device or system, or to affect its safety or effectiveness of that device or system.

² Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.

EU RoHS and China RoHS compliant product



此产品符合欧盟 RoHS 指令的要求；

按照中国的相关法规和标准，不含有毒有害物质或元素。